

# **GE864-QUAD ATEX Hardware User Guide**

1vv0300879 Rev. 1 Preliminary - 04/05/10





# **APPLICABILITY TABLE**

**PRODUCT** 

**GE864-QUAD ATEX** 





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# 1. Introduction

# 1.1. Scope

The aim of this document is the description of some hardware solutions useful for developing a product with the Telit GE864-QUAD ATEX module.

## 1.2. Audience

This document is intended for Telit customers, who are integrators, about to implement their applications using our GE864-QUAD ATEX module.

# 1.3. Contact Information, Support

For general contact, technical support, to report documentation errors and to order manuals, contact Telit's Technical Support Center (TTSC) at:

TS-EMEA@telit.com

TS-NORTHAMERICA@telit.com

TS-LATINAMERICA@telit.com

TS-APAC@telit.com

#### Alternatively, use:

http://www.telit.com/en/products/technical-support-center/contact.php

For detailed information about where you can buy the Telit modules or for recommendations on accessories and components visit:

http://www.telit.com

To register for product news and announcements or for product questions contact Telit's Technical Support Center (TTSC).

Our aim is to make this guide as helpful as possible. Keep us informed of your comments and suggestions for improvements.

Telit appreciates feedback from the users of our information.



# 1.4. Document Organization

This document contains the following chapters:

<u>Chapter 1: "Introduction"</u> provides a scope for this document, target audience, contact and support information, and text conventions.

<u>Chapter 2: "Overview"</u> provides an overview of the document.

Chapter 3: "GE864 Mechanical Dimensions"

Chapter 4: "GE864 Module Connections" deals with the pin out configuration and layout.

<u>Chapter 5: "Hardware Commands"</u> How to operate on the module via hardware.

<u>Chapter 6: "Power supply"</u> Power supply requirements and general design rules.

Chapter 7: "Temperature sense limit"

<u>Chapter 8: "Antenna"</u> The antenna connection and board layout design are the most important parts in the full product design.

<u>Chapter 9: "Logic Level specifications"</u> Specific values adopted in the implementation of logic levels for this module.

<u>Chapter 10: "Serial ports"</u> The serial port on the Telit GE864- QUAD ATEX is the core of the interface between the module and OEM hardware

<u>Chapter 11: "Audio Section overview"</u> Refers to the audio blocks of the Base Band Chip of the GE864 Telit Modules.

<u>Chapter 12: "General Purpose I/O"</u> How the general purpose I/O pads can be configured.

Chapter 13 "DAC and ADC Section" Deals with these two kind of converters.

<u>Chapter 14 "Conformity Assessment issues"</u> Deals with the assessments of the module.

Chapter 15 "Safety Recommendations"





#### 1.5. Text Conventions



<u>Danger – This information MUST be followed or catastrophic equipment failure or bodily injury may occur.</u>



Caution or Warning — Alerts the user to important points about integrating the module, if these points are not followed, the module and end user equipment may fail or malfunction.



Tip or Information — Provides advice and suggestions that may be useful when integrating the module.

All dates are in ISO 8601 format, i.e. YYYY-MM-DD.

#### 1.6. Related Documents

- GE864-QUAD ATEX Product description, 80336ST10052a
- Telit's GSM/GPRS Family Software User Guide, 1vv0300784
- AT Commands Reference Guide, 80000ST10025a
- Audio settings application note, 80000NT10007a
- Digital voice Interface Application Note, 80000NT10004a
- SIM Holder Design Guides, 80000NT10001a



## 1.7. Document History

Revision	Date	Changes
ISSUE#0	2010-03-26	Release First Preliminary ISSUE# 0 – this document puts in EOL the old GE864-QUAD ATEX Hardware User Guide 1vv0300801
ISSUE#1	2010-05-04	Second preliminary issue.  New layout V2 compliant.  §4: updated Pin-out table: ball F3 becomes RESERVED. External 32 KHz is not required.  Added ball F9 (RTS) in table containing pins must be left connected if not used.  Added note about RTS: must be connected to GND if flow control is not used.  §6: Power Supply: updated electrical parameters for IIC,IIB,IIA gas classes
		Added § 6.1.1 " ATEX useful parameters"



## 2. Overview

The aim of this document is the description of some hardware solutions useful for developing a product with the **Telit GE864-QUAD ATEX** module.

In this document all the basic functions of a mobile module will be taken into account; for each one of them a proper hardware solution will be suggested and eventually the wrong solutions and common errors to be avoided will be evidenced. Obviously, this document cannot embrace the whole hardware solutions and products that may be designed. The wrong solutions to be avoided shall be considered as mandatory, while the suggested hardware configurations shall not be considered mandatory, instead the information given shall be used as a guide and a starting point for properly developing your product with the **Telit GE864-QUAD ATEX** module. For further general details that may not be explained in this document refer to the Telit GE864-QUAD ATEX Product Description document where general information as well as approvals are reported.



**NOTE:** The integration of the GSM/GPRS GE864-QUAD ATEX cellular module within user application shall be done according to the design rules described in this manual.

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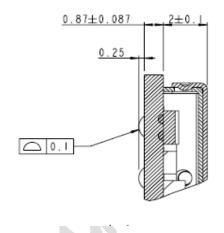


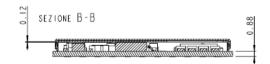
# 3. GE864-QUAD ATEX Mechanical Dimensions

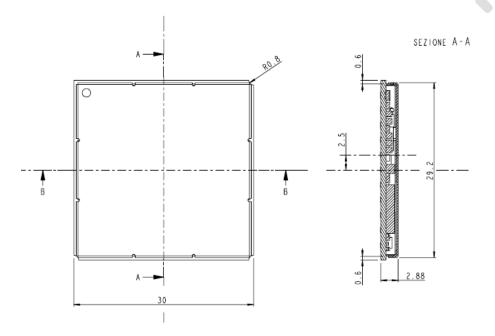
The Telit GE864-QUAD ATEX module overall dimension are:

Length: 30 mmWidth: 30 mm

• Thickness: 2.8 mm









#### **GE864-QUAD ATEX module connections** 4.

#### 4.1. **PIN-OUT**

Ball	Signal	1/0	Function	Internal PULL UP	Туре
			Audio		
F9	AXE	1	Handsfree switching	100K	CMOS 2.8V
G8	MIC_HF+	Al	Handsfree mic. input; phase +, nom. level 3mVrms		Audio
G9	MIC_MT-	Al	Handset mic.signal input; phase-, nom. level 50mVrms		Audio
G10	EAR_MT+	AO	Handset earphone signal output, phase +		Audio
<b>J8</b>	MIC_MT+	Al	Handset mic.signal input; phase+, nom. level 50mVrms		Audio
J9	MIC_HF-	Al	Handsfree mic.input; phase -, nom. level 3mVrms		Audio
J10	EAR_HF-	AO	Handsfree ear output, phase -		Audio
H9	EAR_MT-	AO	Handset earphone signal output, phase -		Audio
H10	EAR_HF+	AO	Handsfree ear output, phase +		Audio
			SIM card interface		
C10	SIMCLK	0	External SIM signal – Clock		1,8 / 3V
C11	SIMIN	1	External SIM signal - Presence (active low)	47K	1,8 / 3V
D4	SIMVCC	-	External SIM signal – Power supply for the SIM		1,8 / 3V
D10	SIMI0	1/0	External SIM signal - Data I/O		1,8 / 3V
E9	SIMRST	0	External SIM signal – Reset		1,8 / 3V
			Trace		
D11	TX_TRACE	0	TX Data for debug monitor		CMOS 2.8V
F10	RX_TRACE	1	RX Data for debug monitor		CMOS 2.8V
H4	Service	Γ	Service pin shall be used to upgrade the module from ASC1 (RX_TRACE, TX_TRACE). The pin shall be tied low to enable the feature only in case of a SW Update activity. It is required, for debug purpose, to be connected to a test pad on the final application.		CMOS 2.8V
			Prog. / Data + HW Flow Control		
B6	C125/RING	0	Output for Ring indicator signal (RI) to DTE		CMOS 2.8V
В7	C108/DTR	I	Input for Data terminal ready signal (DTR) from DTE		CMOS 2.8V
D9	C109/DCD	0	Output for Data carrier detect signal (DCD) to DTE		CMOS 2.8V
E7	C103/TXD	1	Serial data input (TXD) from DTE		CMOS 2.8V
E11	C107/DSR	0	Output for Data set ready signal (DSR) to DTE		CMOS 2.8V
F7	C105/RTS	1	Input for Request to send signal (RTS) from $\ensuremath{DTE}$		CMOS 2.8V
F6	C106/CTS	0	Output for Clear to send signal (CTS) to DTE		CMOS 2.8V
H8	C104/RXD	0	Serial data output to DTE		CMOS 2.8V
			DAC and ADC		
C7	DAC_OUT	AO	Digital/Analog converter output		D/A





























Main	Ball	Signal	1/0	Function	Internal PULL UP	Туре			
Miscellaneous Functions	J11	ADC_IN1	Al	Analog/Digital converter input		A/D			
A2         RESET*         I         Reset input         CMOS 1.8V           DB         STAT_LED         0         Status indicator led         CMOS 1.8V           E2         VRTC         A0         VRTC         Power           J5         ON_OFF*         I loggle command. The pulse to be sent to the 6E864-QUAD ATEX must be equat or greater than 1 second.         CMOS 2.8V           L8         PWRMON         0         Power ON Monitor         CMOS 2.8V           L4         Antenna         0         Antenna output - 50 ohm         RF           Teitt GPIO           E6         GPIO_01/ JDR         I/O         Teit GPIO1/ I/O Jin / Jammer detect report         CMOS 2.8V           H5         GPIO_02/PCM_WAO         I/O         Teit GPIO2 Configurable GPIO / PCM audio *         CMOS 2.8V           K7         GPIO_03 / PCM_RX         I/O         Teit GPIO3 Configurable GPIO / PCM audio *         CMOS 2.8V           K8         GPIO_04         I/O         Teit GPIO3 Configurable GPIO / PCM audio *         CMOS 2.8V           K8         GPIO_05 / RFTXMON         I/O         Teit GPIO3 Configurable GPIO / PCM audio *         CMOS 2.8V           L9         GPIO_07 / BUZZER         I/O         Teit GPIO3 Configurable GPIO / PCM audio *         CMOS 2.8V	H11	ADC_IN2	Al	Analog/Digital converter input		A/D			
DB         STAT_LED         0         Status indicator led         CMOS 1.8V           E2         VRTC         AO         VRTC         Power           JS         VRTC         AO         VRTC         Power           JS         ON_OFF*         I         Input command for switching power ON or OFF loggle command. The pulse to be sent to the GE864-OUAD ATEX must be equal or greater than 1 second.         47K         Pull up to VBATT Pull of The VBATT Pull of	Miscellaneous Functions								
February   February	A2	RESET*	I	Reset input					
Input command for switching power ON or OFF   I   Deglet command. The pulse to be sent to the GES64-OUAD ATEX must be equal or greater than 1 second.	D8	STAT_LED	0	Status indicator led		CMOS 1.8V			
1	E2	VRTC	AO			Power			
L4	J5	ON_OFF*	1	(toggle command). The pulse to be sent to the GE864-QUAD ATEX must be equal or greater	ggle command). The pulse to be sent to the 864-QUAD ATEX must be equal or greater				
Telit GPI0	L8	PWRMON	0	Power ON Monitor		CMOS 2.8V			
E6         GPIO_01 / JDR         I/O         Telit GPI001 I/O pin / Jammer detect report         CMOS 2.8V           H5         GPIO_02 / PCM_WAO         I/O         Telit GPI002 Configurable GPI0 / PCM audio *         CMOS 2.8V           K7         GPIO_03 / PCM_RX         I/O         Telit GPI003 Configurable GPI0 / PCM audio *         CMOS 2.8V           B3         GPIO_04         I/O         Telit GPI004 Configurable GPI0 / RF Transmission Control         CMOS 2.8V           K8         GPIO_05 / RFTXMON         I/O         Telit GPI005 Configurable GPI0 / Transmitter ON monitor         CMOS 2.8V           B5         GPIO_06 / ALARM         I/O         Telit GPI006 Configurable GPI0 / ALARM         CMOS 2.8V           L9         GPIO_07 / BUZZER         I/O         Telit GPI008 Configurable GPI0 / PCM audio *         CMOS 2.8V           D7         GPIO_08 / PCM_CLK         I/O         Telit GPI008 Configurable GPI0 / PCM audio *         CMOS 2.8V           D7         GPIO_09 / PCM_CLK         I/O         Telit GPI008 Configurable GPI0 / PCM audio *         CMOS 2.8V           D7         GPIO_08 / PCM_CLK         I/O         Telit GPI008 Configurable GPI0 / PCM audio *         CMOS 2.8V           D7         GPIO_08 / PCM_CLK         I/O         Telit GPI008 Configurable GPI0 / PCM audio *         CMOS 2.8V </td <td>L4</td> <td>Antenna</td> <td>0</td> <td>Antenna output – 50 ohm</td> <td></td> <td>RF</td>	L4	Antenna	0	Antenna output – 50 ohm		RF			
H5         GPIO_02/PCM_WAO         I/O         Telit GPI002 Configurable GPIO / PCM audio *         CMOS 2.8V           K7         GPIO_03 / PCM_RX         I/O         Telit GPI003 Configurable GPIO / PCM audio *         CMOS 2.8V           B3         GPIO_04         I/O         Telit GPI003 Configurable GPIO / RF Transmission Control         CMOS 2.8V           K8         GPIO_05 / RFTXMON         I/O         Telit GPI005 Configurable GPIO / Transmitter ON monitor         CMOS 2.8V           B5         GPIO_06 / ALARM         I/O         Telit GPI005 Configurable GPIO / ALARM         CMOS 2.8V           L9         GPIO_07 / BUZZER         I/O         Telit GPI008 Configurable GPIO / Buzzer         CMOS 2.8V           L9         GPIO_09 / PCM_CLK         I/O         Telit GPI008 Configurable GPIO / PCM audio *         CMOS 2.8V           D7         GPIO_09 / PCM_CLK         I/O         Telit GPI008 Configurable GPIO / PCM audio *         CMOS 2.8V           D7         GPIO_09 / PCM_CLK         I/O         Telit GPI008 Configurable GPIO / PCM audio *         CMOS 2.8V           D7         GPIO_09 / PCM_CLK         I/O         Telit GPI008 Configurable GPIO / PCM audio *         CMOS 2.8V           D7         GPIO_09 / PCM_CLK         I/O         Telit GPI008 Configurable GPIO / PCM audio *         CMOS 2.8V           D7<				Telit GPIO					
K7         GPIO_03 / PCM_RX         I/O         Telit GPIO03 Configurable GPIO / RF Transmission Control Telit GPIO04 Configurable GPIO / RF Transmistor Control Telit GPIO05 Configurable GPIO / Transmitter ON monitor         CMOS 2.8V           K8         GPIO_05 / RFTXMON         I/O         Telit GPIO05 Configurable GPIO / Transmitter ON monitor         CMOS 2.8V           B5         GPIO_06 / ALARM         I/O         Telit GPIO06 Configurable GPIO / Buzzer         CMOS 2.8V           L9         GPIO_07 / BUZZER         I/O         Telit GPIO07 Configurable GPIO / Buzzer         CMOS 2.8V           H3         GPIO_08 / PCM_TX         I/O         Telit GPIO08 Configurable GPIO / PCM audio *         CMOS 2.8V           Power Suply         CMOS 2.8V           Power Supply           Power Supply         Power           K1         VBATT         Main power supply         Power           K2         VBATT         Main power supply         Power           K2         VBATT         Main power supply         Power           K2         VBATT         Main power supply         Power           K3         GND         Ground         Power           K4         GND         Ground         Power           K5         GND         Ground	E6	GPI0_01 / JDR	1/0	Telit GPI001 I/O pin / Jammer detect report		CMOS 2.8V			
B3         GPIO_04         I/O         Telit GPIO_04 Configurable GPIO / RF Transmission Control         CMOS 2.8V           K8         GPIO_05 / RFTXMON         I/O         Telit GPIO0S Configurable GPIO / Transmitter ON monitor         CMOS 2.8V           B5         GPIO_06 / ALARM         I/O         Telit GPIO0S Configurable GPIO / Buzzer         CMOS 2.8V           L9         GPIO_09 / PCM_TX         I/O         Telit GPIO08 Configurable GPIO / Buzzer         CMOS 2.8V           D7         GPIO_09 / PCM_TX         I/O         Telit GPIO09 Configurable GPIO / PCM audio *         CMOS 2.8V           Power Supply           Power Supply           J1         VBATT         - Main power supply         Power           K1         VBATT         - Main power supply         Power           K2         VBATT         - Main power supply         Power           K2         VBATT         - Main power supply         Power           K2         VBATT         - Ground         Power           K1         GND         - Ground         Power           K2         VBATT         - Ground         Power           K1         GND         - Ground         Power           F1         GND         - Ground <td>H5</td> <td>GPIO_02/PCM_WAO</td> <td>1/0</td> <td>Telit GPI002 Configurable GPI0 / PCM audio *</td> <td></td> <td>CMOS 2.8V</td>	H5	GPIO_02/PCM_WAO	1/0	Telit GPI002 Configurable GPI0 / PCM audio *		CMOS 2.8V			
B3         GPIO_UA         I/O         Transmission Control Telit GPIO05 Configurable GPIO / Transmitter ON monitor         CMOS 2.8V           B5         GPIO_05 / RFTXMON         I/O         Telit GPIO05 Configurable GPIO / ALARM         CMOS 2.8V           L9         GPIO_07 / BUZZER         I/O         Telit GPIO06 Configurable GPIO / Buzzer         CMOS 2.8V           L9         GPIO_09 / PCM_CLK         I/O         Telit GPIO09 Configurable GPIO / PCM audio *         CMOS 2.8V           POWER SUPPLY           VBATT         -         Main power Supply         Power           K1         VBATT         -         Main power supply         Power           K2         VBATT         -         Main power supply         Power           K3         GND         -         Ground         Power           K4         GND         -         Ground         Power           F11         GND         -         Ground         Power <th< td=""><td>K7</td><td>GPIO_03 / PCM_RX</td><td>1/0</td><td>Telit GPI003 Configurable GPI0 / PCM audio *</td><td></td><td>CMOS 2.8V</td></th<>	K7	GPIO_03 / PCM_RX	1/0	Telit GPI003 Configurable GPI0 / PCM audio *		CMOS 2.8V			
R8         GPIC_US / RFT MUN         I/O         ON monitor         CMUS 2.8V           B5         GPIO_06 / ALARM         I/O         Telit GPI006 Configurable GPI0 / ALARM         CMOS 2.8V           L9         GPIO_07 / BUZZER         I/O         Telit GPI007 Configurable GPI0 / Buzzer         CMOS 2.8V           H3         GPIO_08 / PCM_TX         I/O         Telit GPI008 Configurable GPI0 / PCM audio *         CMOS 2.8V           POWER SUPPLY           FOWER SUPPLY           POWER SUPPLY           VBATT         -         Main power supply         Power           K1         VBATT         -         Main power supply         Power           K2         VBATT         -         Main power supply         Power           K2         VBATT         -         Main power supply         Power           K3         GND         -         Ground         Power           A1         GND         -         Ground         Power           A1         GND         -         Ground         Power           B1         GND         -         Ground         Power           B1         GND         -         Ground         Power	В3	GPI0_04	1/0	Transmission Control		CMOS 2.8V			
L9         GPIO_07 / BUZZER         I/O         Telit GPI007 Configurable GPI0 / Buzzer         CMOS 2.8V           H3         GPIO_08 / PCM_TX         I/O         Telit GPI008 Configurable GPI0 / PCM audio *         CMOS 2.8V           Power Supply           Fower Supply           J1         VBATT         -         Main power supply         Power           K1         VBATT         -         Main power supply         Power           K2         VBATT         -         Main power supply         Power           K2         VBATT         -         Main power supply         Power           K1         GND         -         Ground         Power           K1         GND         -         Ground         Power           K2         VBATT         -         Main power supply         Power           K3         GND         -         Ground         Power           K4         GND         -         Ground         Power           K4         GND         -         Ground         Power           K4         GND         -         Ground         Power           K5         GND         -         Ground	K8	GPIO_05 / RFTXMON	1/0						
H3         GPIO_08 / PCM_TX         I/O         Telit GPIO08 Configurable GPIO / PCM audio *         CMOS 2.8V           Power Supply         CMOS 2.8V           Power Supply         Power Supply           J1 VBATT         - Main power supply         Power           K1 VBATT         - Main power supply         Power           J2 VBATT         - Main power supply         Power           A1 GND         - Ground         Power           A11 GND         - Ground         Power           A11 GND         - Ground         Power           F11 GND         - Ground         Power           F11 GND         - Ground         Power           H1 GND         - Ground         Power           H2 GND         - Ground         Power           K3 GND         - Ground         Power           K4 GND         - Ground         Power           K5 GND         - Ground         Power           K6	B5	GPIO_06 / ALARM	1/0	Telit GPI006 Configurable GPIO / ALARM		CMOS 2.8V			
D7         GPIO_09 / PCM_CLK         I/O         Telit GPI009 Configurable GPI0 / PCM audio *         CMOS 2.8V           Power Supply           Power Supply           K1         VBATT         -         Main power supply         Power           J2         VBATT         -         Main power supply         Power           K2         VBATT         -         Main power supply         Power           A1         GND         -         Ground         Power           A11         GND         -         Ground         Power           A11         GND         -         Ground         Power           B0         -         Ground         Power           F1         GND         -         Ground         Power           F11         GND         -         Ground         Power           F11         GND         -         Ground         Power           H1         GND         -         Ground         Power           H2         GND         -         Ground         Power           K3         GND         -         Ground         Power           K4         GND         -         <	L9	GPIO_07 / BUZZER	1/0	Telit GPI007 Configurable GPI0 / Buzzer		CMOS 2.8V			
Power Supply           J1         VBATT         -         Main power supply         Power           K1         VBATT         -         Main power supply         Power           J2         VBATT         -         Main power supply         Power           K2         VBATT         -         Main power supply         Power           A1         GND         -         Ground         Power           A11         GND         -         Ground         Power           A11         GND         -         Ground         Power           B0         GND         -         Ground         Power           F1         GND         -         Ground         Power           F11         GND         -         Ground         Power           H1         GND         -         Ground         Power           H2         GND         -         Ground         Power           K3         GND         -         Ground         Power           K4         GND         -         Ground         Power           K5         GND         -         Ground         Power           L1         <	Н3	GPIO_08 / PCM_TX	1/0	Telit GPI008 Configurable GPI0 / PCM audio *		CMOS 2.8V			
J1         VBATT         -         Main power supply         Power           K1         VBATT         -         Main power supply         Power           J2         VBATT         -         Main power supply         Power           K2         VBATT         -         Main power supply         Power           A1         GND         -         Ground         Power           A11         GND         -         Ground         Power           B06         GND         -         Ground         Power           F1         GND         -         Ground         Power           F11         GND         -         Ground         Power           F11         GND         -         Ground         Power           H1         GND         -         Ground         Power           H2         GND         -         Ground         Power           K3         GND         -         Ground         Power           K4         GND         -         Ground         Power           K5         GND         -         Ground         Power           L1         GND         -         Ground	D7	GPIO_09 / PCM_CLK	1/0	Telit GPI009 Configurable GPI0 / PCM audio *		CMOS 2.8V			
K1       VBATT       - Main power supply       Power         J2       VBATT       - Main power supply       Power         K2       VBATT       - Main power supply       Power         A1       GND       - Ground       Power         A11       GND       - Ground       Power         B0D       - Ground       Power     <				Power Supply					
J2       VBATT       -       Main power supply       Power         K2       VBATT       -       Main power supply       Power         A1       GND       -       Ground       Power         A11       GND       -       Ground       Power         D6       GND       -       Ground       Power         F1       GND       -       Ground       Power         F11       GND       -       Ground       Power         H1       GND       -       Ground       Power         H2       GND       -       Ground       Power         K3       GND       -       Ground       Power         K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         L1       GND       -       Ground       Power         L2       GND       -       Ground       Power         L3       GND       -       Ground       Power	J1	VBATT	-	Main power supply		Power			
K2       VBATT       -       Main power supply       Power         A1       GND       -       Ground       Power         A11       GND       -       Ground       Power         D6       GND       -       Ground       Power         F1       GND       -       Ground       Power         F11       GND       -       Ground       Power         H1       GND       -       Ground       Power         H2       GND       -       Ground       Power         K3       GND       -       Ground       Power         K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         K6       GND       -       Ground       Power         L1       GND       -       Ground       Power         L2       GND       -       Ground       Power         L3       GND       -       Ground       Power	K1	VBATT	-	Main power supply		Power			
A1       GND       -       Ground       Power         A11       GND       -       Ground       Power         D6       GND       -       Ground       Power         F1       GND       -       Ground       Power         F11       GND       -       Ground       Power         H1       GND       -       Ground       Power         H2       GND       -       Ground       Power         K3       GND       -       Ground       Power         K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         K6       GND       -       Ground       Power         L1       GND       -       Ground       Power         L2       GND       -       Ground       Power	J2	VBATT	-	Main power supply		Power			
A11       GND       -       Ground       Power         D6       GND       -       Ground       Power         F1       GND       -       Ground       Power         F11       GND       -       Ground       Power         H1       GND       -       Ground       Power         H2       GND       -       Ground       Power         J3       GND       -       Ground       Power         K3       GND       -       Ground       Power         K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         L1       GND       -       Ground       Power         L1       GND       -       Ground       Power         L3       GND       -       Ground       Power	K2	VBATT	-	Main power supply		Power			
D6         GND         -         Ground         Power           F1         GND         -         Ground         Power           F11         GND         -         Ground         Power           H1         GND         -         Ground         Power           H2         GND         -         Ground         Power           J3         GND         -         Ground         Power           K3         GND         -         Ground         Power           K4         GND         -         Ground         Power           K5         GND         -         Ground         Power           L1         GND         -         Ground         Power           L2         GND         -         Ground         Power           L3         GND         -         Ground         Power	A1	GND	-	Ground		Power			
F1       GND       -       Ground       Power         F11       GND       -       Ground       Power         H1       GND       -       Ground       Power         H2       GND       -       Ground       Power         J3       GND       -       Ground       Power         K3       GND       -       Ground       Power         K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         L1       GND       -       Ground       Power         L2       GND       -       Ground       Power         L3       GND       -       Ground       Power	A11	GND	-	Ground		Power			
F11       GND       -       Ground       Power         H1       GND       -       Ground       Power         H2       GND       -       Ground       Power         J3       GND       -       Ground       Power         K3       GND       -       Ground       Power         K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         L1       GND       -       Ground       Power         L2       GND       -       Ground       Power         L3       GND       -       Ground       Power	D6	GND	-	Ground		Power			
H1       GND       -       Ground       Power         H2       GND       -       Ground       Power         J3       GND       -       Ground       Power         K3       GND       -       Ground       Power         K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         L1       GND       -       Ground       Power         L2       GND       -       Ground       Power         L3       GND       -       Ground       Power	F1	GND	-	Ground		Power			
H2       GND       -       Ground       Power         J3       GND       -       Ground       Power         K3       GND       -       Ground       Power         K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         L1       GND       -       Ground       Power         L2       GND       -       Ground       Power         L3       GND       -       Ground       Power	F11	GND	-	Ground		Power			
J3         GND         -         Ground         Power           K3         GND         -         Ground         Power           K4         GND         -         Ground         Power           K5         GND         -         Ground         Power           K6         GND         -         Ground         Power           L1         GND         -         Ground         Power           L2         GND         -         Ground         Power           L3         GND         -         Ground         Power	H1	GND	-	Ground		Power			
K3       GND       -       Ground       Power         K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         K6       GND       -       Ground       Power         L1       GND       -       Ground       Power         L2       GND       -       Ground       Power         L3       GND       -       Ground       Power	H2	GND	-	Ground		Power			
K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         K6       GND       -       Ground       Power         L1       GND       -       Ground       Power         L2       GND       -       Ground       Power         L3       GND       -       Ground       Power	J3	GND	-	Ground		Power			
K4       GND       -       Ground       Power         K5       GND       -       Ground       Power         K6       GND       -       Ground       Power         L1       GND       -       Ground       Power         L2       GND       -       Ground       Power         L3       GND       -       Ground       Power	К3	GND	-	Ground		Power			
K5         GND         -         Ground         Power           K6         GND         -         Ground         Power           L1         GND         -         Ground         Power           L2         GND         -         Ground         Power           L3         GND         -         Ground         Power		GND	-	Ground		Power			
K6         GND         -         Ground         Power           L1         GND         -         Ground         Power           L2         GND         -         Ground         Power           L3         GND         -         Ground         Power			-						
L1         GND         -         Ground         Power           L2         GND         -         Ground         Power           L3         GND         -         Ground         Power			-						
L2         GND         -         Ground         Power           L3         GND         -         Ground         Power									
L3 GND - Ground Power									



























Ball	Signal	1/0	Function	Internal PULL UP	Туре				
L11	GND	-	Ground		Power				
	RESERVED								
А3	-	-	Reserved						
A4	-	-	Reserved						
A5	-	-	Reserved						
A6	-	-	Reserved						
Α7	-	-	Reserved						
A8	-	-	Reserved						
Α9	-	-	Reserved						
A10	-	-	Reserved						
B1	-	-	Reserved						
B2	-	-	Reserved						
B4	-	-	Reserved						
B8	-	-	Reserved						
B9	-	-	Reserved						
B10	-	-	Reserved						
B11	-	-	Reserved						
C1	-	-	Reserved						
C2	-	-	Reserved						
C3	-	-	Reserved						
C4	-	-	Reserved						
C5	-	-	Reserved						
C6	-	-	Reserved						
C8	-	-	Reserved						
C9	-	-	Reserved						
D1	-	-	Reserved						
D2	-	-	Reserved						
D3	-	-	Reserved						
D5	-	-	Reserved						
E1	-	-	Reserved						
E3	-	-	Reserved						
E4	-	-	Reserved						
E5	-	-	Reserved						
E8	-	-	Reserved						
E10	-	-	Reserved						
F2	-	-	Reserved						
F3	-	-	Reserved						
F4	-	-	Reserved						
F5	-	-	Reserved						
F8	-	-	Reserved						
G1	-	-	Reserved						
G2	-	-	Reserved						
G3	-	-	Reserved						
G4	-	-	Reserved						



























Ball	Signal	1/0	Function	Internal PULL UP	Туре
G5	-	-	Reserved		
G6	-	-	Reserved		
G7	-	-	Reserved		
G11	-	-	Reserved		
H6	-	-	Reserved		
H7	-	-	Reserved		
J4	-	-	Reserved		
J6	-	-	Reserved		
J7	-	-	Reserved		
K9	-	-	Reserved		
K10	-	-	Reserved		
K11	-	-	Reserved		
L5	-	-	Reserved		
L7	-	-	Reserved		
L10	-	-	Reserved		

<sup>\*</sup> Ref. to Digital Voice Interface Application Note 80000NT10004a.



WARNING: RESERVED pins must not be connected



NOTE: If not used, almost all pins should be left disconnected. The only exceptions are the following pins:

pin	signal
J1,K1,J2,K2	VBATT
A1,F1,H1,L1,H2,L2,J3,K3,L3,	GND
K4,K5,D6,K6,L6,A11,F11,L11	
J5	ON/OFF*
E7	TXD
A2	RESET*
Н8	RXD
D11	TX TRACE
F10	RX TRACE
H4	Service
F7	GND



NOTE: RTS (ball F7) should be connected to GND (on the module side) if flow control is not used



























# 4.1.1. BGA Balls Layout

#### **TOP VIEW**

	Α	В	С	D	E	F	G	Н	J	К	L
1	GND	-	-	-	-	GND	-	GND	VBATT	VBATT	GND
2	RESET*	-	-	-	VRTC	-	-	GND	VBATT	VBATT	GND
3	-		-	1	-	-		GPIO_08 / PCM_TX	GND	GND	GND
4	1	-	·	SIMVCC	-		ì	Service	-	GND	Antenna
5	1	GPIO_06 / ALARM	-	-	1	ı		GPIO_02 / PCM_WAO	ON_OFF*	GND	-
6	1	C125/RING		GND	GPIO_01 / JDR	C106 / CTS	•	ı	-	GND	GND
7		C108 / DTR	DAC_OUT	GPIO_09 / PCM_CLK	C103 / TXD	C105 / RTS	-	ı	-	GPIO_03/ PCM_RX	-
8	1		·	STAD_LED	-	-	MIC_HF+	C104 / RXD	MIC_MT+	GPIO_05/ RFTXMON	PWRMON
9	-	-		C109 / DCD	SIMRST	AXE	MIC_MT-	EAR_MT-	MIC_HF-	-	GPIO_07 / BUZZER
10	-		SIMCLK	SIMIO	-	RX_TRACE	EAR_MT+	EAR_HF+	EAR_HF-	-	-
11	GND	-	SIMIN	TX_TRACE	C107 / DSR	GND	-	ADC_IN2	ADC_IN1	-	GND



AUDIO Signals balls
SIM CARD interface balls
TRACE Signals balls
Prog. / data + Hw Flow Control signals balls
ADC signals balls
MISCELLANEOUS functions signals balls
TELIT GPIO balls
POWER SUPPLY VBATT balls
POWER SUPPLY GND balls
RESERVED

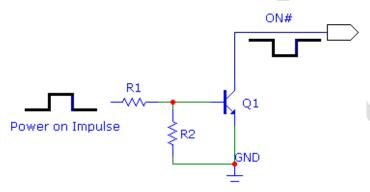


## 5. Hardware Commands

# 5.1. Turning ON the GE864- QUAD ATEX

To turn the GE864- QUAD ATEX on, the pad ON# must be tied low for at least 1000ms and then released. Pulse duration less than 1000ms should also start the power on procedure, but this is not guaranteed.

The maximum current that can be drained from the ON# pad is 0.1 mA. A simple circuit to do it is:





#### TIP:

To check if the device has powered on, the hardware line PWRMON must be monitored. After 1000ms the line raised up the device could be considered powered on.

#### NOTE:

Do not use any pull up resistor on the ON# line, it is internally pulled up. Using pull up resistor may bring to latch up problems on the power regulator and improper power on/off of the module. The line ON# must be connected only in open collector configuration.

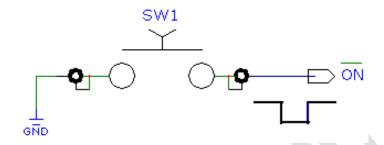
In this document all the lines that are inverted, hence have active low signals are labeled with a name that ends with a "#" or with a bar over the name.

#### For example:

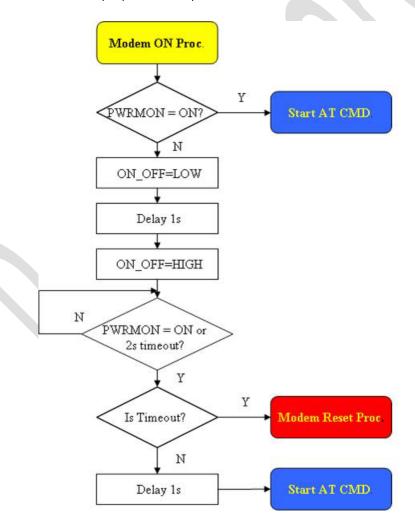




- 1- Let us assume you need to drive the ON# pad with a totem pole output of a +3/5 V microcontroller (uP\_OUT1):
- 2- Let us assume you need to drive the ON# pad directly with an ON/OFF button:



A flow chart with proper turn on procedure is detailed below:





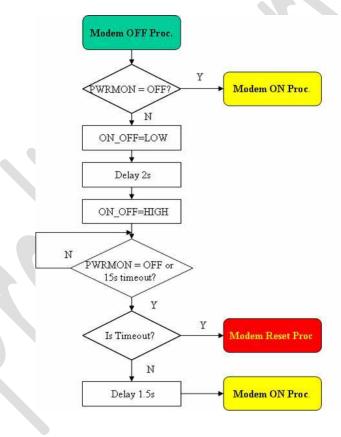
# 5.2. Turning OFF the GE864- QUAD ATEX

Turning off of the device can be done in three ways:

- by software command (see GE864- QUAD ATEX Software User Guide)
- by tying low pin ON#

Either ways, the device issues a detach request to network informing that the device will not be reachable any more. To turn OFF the GE864-QUAD ATEX via pin ON#, this must be tied low for at least 1000ms and then released. The same circuitry and timing for the power on shall be used. The device shuts down after the release of the ON# pin.

The following flow chart shows the proper turnoff procedure:





#### TIP:

To check if the device has powered off, the hardware line PWRMON must be monitored. When PWRMON goes low, then the device has powered off.





#### 5.2.1. Hardware Unconditional Restart

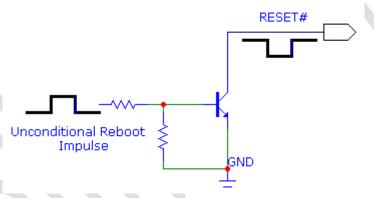


#### **WARNING:**

The hardware unconditional Restart must not be used during normal operation of the device since it does not detach the device from the network. It shall be kept as an emergency exit procedure to be done in the rare case that the device gets stacked waiting for some network or SIM responses.

To unconditionally restart the GE864- QUAD ATEX, the pad RESET# must be tied low for at least 200 ms and then released.

The maximum current that can be drained from the RESET# pad is 0.15 mA. A simple circuit to do it is:





#### NOTE:

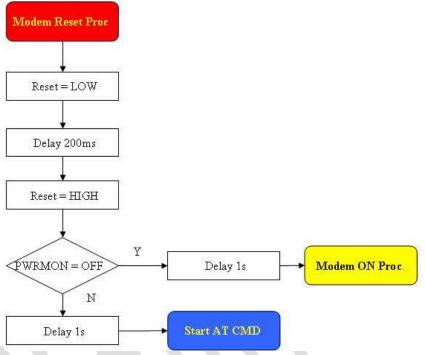
Do not use any pull up resistor on the RESET\* line nor any totem pole digital output. Using pull up resistor may cause latch up problems on the GE864- QUAD ATEX power regulator and improper functioning of the module. The line RESET\* must be connected only in open collector configuration.

#### TIP:

The unconditional hardware reboot must always be implemented on the boards and the software must use it as an emergency exit procedure.

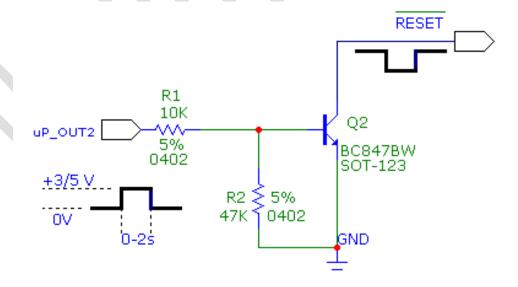


In the following flow chart is detailed the proper restart procedure:



For example:

1- Let us assume you need to drive the RESET# pad with a totem pole output of a +3/5 V microcontroller (uP\_OUT2):





# 6. Power Supply

The power supply circuitry and board layout are a very important part in the full product design and they strongly reflect on the product overall performances, hence read carefully the requirements and the guidelines that will follow for a proper design.

# 6.1. Power Supply Requirements

POWER SUPPLY					
Nominal Supply Voltage	3.8V				
Max Supply Voltage	4.2V				
Operating Supply Voltage Range	3.4V - 4.2V				
Wide Supply Voltage tolerant 3.25V -					



TIP: the supply voltage is directly measured between VBATT and GND balls. It must stay within the Wide Supply Voltage tolerant range including any drop voltage and overshoot voltage (during the slot TX, for example).

**NOTE**: The Operating Voltage Range MUST never be exceeded also in power off condition; care must be taken in order to fulfill min/max voltage requirement

**NOTE**: When the power supply voltage is lower than 3.4V, to turn ON the module, the pad ON# must be tied low for at least 3 seconds.

# 6.1.1. ATEX useful parameters

In order to integrate the Telit Telit GE864-QUAD Atex module in ATEX applications, please refer to the appropriate ATEX reference standard. ATEX reference standard depends either by your ATEX application and either by the working hazardous area classification.

Below are listed parameters and useful information to integrate the module in your application:

- Total capacity: 30.2 µF
  Total inductance: 60.7 nH
- No voltage upper than the supply voltage is present into the module.
- All GPIOs are protected against short circuit.





#### Supply parameters for intrinsic safety 6.1.2.

Mounting and wiring operations in classified areas for explosive gas atmospheres, must be executed accordingly to the current procedures and to the national and international standards (e.g. EN 60079-14) only by qualified personnel specifically and completely trained.

Supply power to the transmitter by means of an apparatus certified for the protection mode Ex ia IIC T4 according to the European standards EN 60079-0 and EN 60079-11 with the following limits:

- Rated max. voltage Ui = 4.2 V;
- Short circuit current li = 2.5 A;
- Maximum transferred power Pi = 10.5W

Specific parameters for IIC Gas Group

Pi = 5.3 W

Ui = 3.8 V

li = 1.4 A

Specific parameters for IIA/IIB Gas Group

Pi = 10.5 W

Ui = 4.2 V

Ii = 2.5 A



























# 6.2. Power Consumption

The GE864-QUAD ATEX power consumptions are:

		GE864-QUAD Atex		
Mode	Average (mA)	Mode description		
SWITCHED (	OFF	Module supplied but Switched Off		
Switched Off	<62 uA	Module supplied but Switched Off		
		IDLE mode		
AT+CFUN=1	19.0	Normal mode: full functionality of the module		
AT+CFUN=4	18.0	Disabled TX and RX; module is not registered on the network		
	3.9	Paging Multiframe 2		
AT+CFUN=0 or =5	2.9	Paging Multiframe 4		
ATTCFUN-U UI -3	2.1	Paging Multiframe 6		
	1.9	Paging Multiframe 8		
	1.6	Paging Multiframe 9		
CSD TX and RX	mode			
GSM900 CSD PL5	300	GSM VOICE CALL		
DCS1800 CSD PL0	200			
GPRS (class 10	) 1TX			
GSM900 PL5	260	GPRS Sending data mode		
DCS1800 PL0 170				
GPRS (class 10	) 2TX			
GSM900 PL5	470	GPRS Sending data mode		
DCS1800 PL0	300			

The GSM system is made in a way that the RF transmission is not continuous, else it is packed into bursts at a base frequency of about 216 Hz, the relative current peaks can be as high as about 2A. Therefore the power supply has to be designed in order to withstand with these current peaks without big voltage drops; this means that both the electrical design and the board layout must be designed for this current flow.

If the layout of the PCB is not well designed a strong noise floor is generated on the ground and the supply; this will reflect on all the audio paths producing an audible annoying noise at 216 Hz; if the voltage drop during the peak current absorption is too much, then the device may even shutdown as a consequence of the supply voltage drop.



**TIP:** The electrical design for the Power supply should be made ensuring it will be capable of a peak current output of at least 2A.



# 6.3. General Design Rules

The principal guidelines for the Power Supply Design embrace three different design steps:

- the electrical design
- the thermal design
- the PCB layout.

## 6.3.1. Electrical Design Guidelines

The electrical design of the power supply depends strongly from the power source where this power is drained. We will distinguish them into three categories:

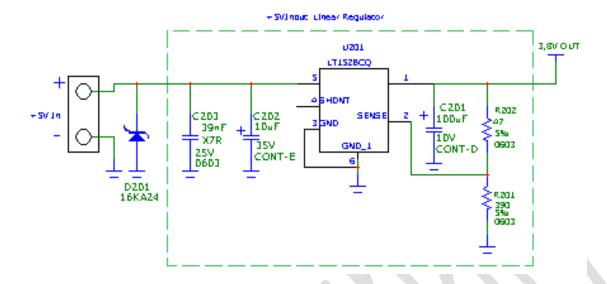
- +5V input (typically PC internal regulator output)
- +12V input
- Battery

#### 6.3.1.1. + 5V input Source Power Supply Design Guidelines

- The desired output for the power supply is 3.8V, hence there's not a big difference between the input source and the desired output and a linear regulator can be used. A switching power supply will not be suited because of the low drop out requirements.
- When using a linear regulator, a proper heat sink shall be provided in order to dissipate the power generated.
- A Bypass low ESR capacitor of adequate capacity must be provided in order to cut the current absorption peaks close to the GE864-QUAD ATEX, a  $100\mu F$  capacitor is usually suited.
- Make sure the low ESR capacitor on the power supply output is rated at least 10V
- A protection diode should be inserted close to the power input, in order to save the GE864-QUAD ATEX from power polarity inversion.



An example of linear regulator with 5V input is:



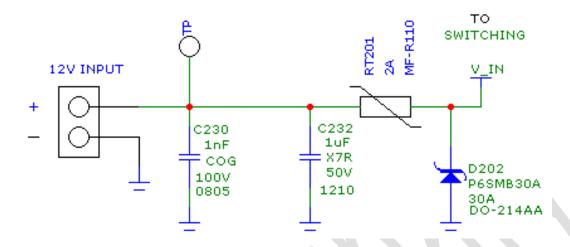


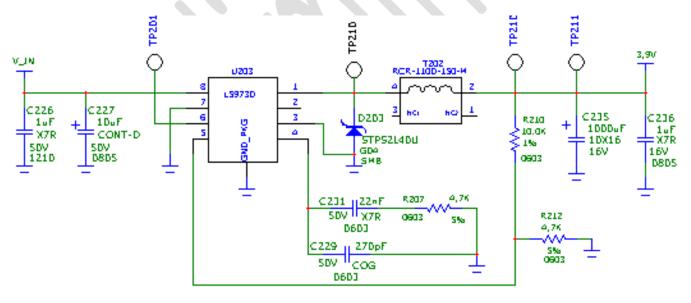
#### 6.3.1.2. + 12V input Source Power Supply Design Guidelines

- The desired output for the power supply is 3.8V, hence due to the big difference between the input source and the desired output, a linear regulator is not suited and shall not be used. A switching power supply will be preferable because of its better efficiency especially with the 2A peak current load represented by the GE864-QUAD ATEX.
- When using a switching regulator, a 500kHz or more switching frequency regulator is preferable because of its smaller inductor size and its faster transient response. This allows the regulator to respond quickly to the current peaks absorption.
- In any case the frequency and Switching design selection is related to the application to be developed due to the fact the switching frequency could also generate EMC interferences.
- For car PB battery the input voltage can rise up to 15,8V and this should be kept in mind when choosing components: all components in the power supply must withstand this voltage.
- A Bypass low ESR capacitor of adequate capacity must be provided in order to cut the current absorption peaks, a 100µF capacitor is suited.
- Make sure the low ESR capacitor on the power supply output is rated at least 10V
- For Car applications a spike protection diode should be inserted close to the power input, in order to clean the supply from spikes.
- A protection diode should be inserted close to the power input, in order to save the GE864-QUAD ATEX from power polarity inversion. This can be the same diode as for spike protection.



An example of switching regulator with 12V input is in the below schematic (it is split in 2 parts):





SWITCHING REGULATOR



#### 6.3.1.3. Battery Source Power Supply Design Guidelines

The desired nominal output for the power supply is 3.7V and the maximum voltage allowed is 4.2V, hence a single 3.7V Li-lon cell battery type is suited for supplying the power to the Telit GE864-QUAD ATEX module.

The three cells Ni/Cd or Ni/MH 3.6 V Nom. battery types or 4V PB types <u>MUST NOT BE</u> <u>USED DIRECTLY</u> since their maximum voltage can rise over the absolute maximum voltage for the GE864-QUAD ATEX and damage it.



**NOTE:** DON'T USE any Ni-Cd, Ni-MH, and Pb battery types directly connected with GE864-QUAD ATEX. Their use can lead to overvoltage on the GE864-QUAD ATEX and damage it. USE ONLY Li-Ion battery types.

- A Bypass low ESR capacitor of adequate capacity must be provided in order to cut the current absorption peaks, a 100µF capacitor is usually suited.
- Make sure the low ESR capacitor is rated at least 10V.
- A protection diode should be inserted close to the power input, in order to save the GE864-QUAD ATEX from power polarity inversion. Otherwise the battery connector should be done in a way to avoid polarity inversions when connecting the battery.
- The battery capacity must be at least 500mAh in order to withstand the current peaks of 2A; the suggested capacity is from 500mAh to 1000mAh.





# 6.3.2. Thermal Design Guidelines

The thermal design for the power supply heat sink should be done with the following specifications:

- Average current consumption during transmission @PWR level max: 500mA
- Average current consumption during transmission @ PWR level min: 100mA
- Average current during Power Saving (CFUN=5): from 1.6 to 3.9mA
- Average current during idle (Power Saving disabled): 19mA



**NOTE**: The average consumption during transmissions depends on the power level at which the device is requested to transmit by the network. The average current consumption hence varies significantly.

Considering the very low current during idle, especially if Power Saving function is enabled, it is possible to consider from the thermal point of view that the device absorbs current significantly only during calls.

If we assume that the device stays into transmission for short periods of time (let's say few minutes) and then remains for a quite long time in idle (let's say one hour), then the power supply has always the time to cool down between the calls and the heat sink could be smaller than the calculated one for 500mA maximum RMS current, or even could be the simple chip package (no heat sink).

Moreover in the average network conditions the device is requested to transmit at a lower power level than the maximum and hence the current consumption will be less than the 500mA, being around 150mA.

For these reasons the thermal design is rarely a concern and the simple ground plane where the power supply chip is placed can be enough to ensure a good thermal condition and avoid overheating.

For the heat generated by the GE864-QUAD ATEX, you can consider it to be during transmission 1W max during CSD/VOICE calls and 2W max during class10 GPRS upload. This generated heat will be mostly conducted to the ground plane under the GE864-QUAD ATEX; you must ensure that your application can dissipate it.



# 6.3.3. Power Supply PCB layout Guidelines

As seen on the electrical design guidelines the power supply shall have a low ESR capacitor on the output to cut the current peaks and a protection diode on the input to protect the supply from spikes and polarity inversion. The placement of these components is crucial for the correct working of the circuitry. A misplaced component can be useless or can even decrease the power supply performances.

- The Bypass low ESR capacitor must be placed close to the Telit GE864-QUAD ATEX power input pads or in the case the power supply is a switching type it can be placed close to the inductor to cut the ripple provided the PCB trace from the capacitor to the GE864-QUAD ATEX is wide enough to ensure a dropless connection even during the 2A current peaks.
- The protection diode must be placed close to the input connector where the power source is drained.
- The PCB traces from the input connector to the power regulator IC must be wide enough to ensure no voltage drops occur when the 2A current peaks are absorbed. Note that this is not made in order to save power loss but especially to avoid the voltage drops on the power line at the current peaks frequency of 216 Hz that will reflect on all the components connected to that supply, introducing the noise floor at the burst base frequency. For this reason while a voltage drop of 300-400 mV may be acceptable from the power loss point of view, the same voltage drop may not be acceptable from the noise point of view. If your application doesn't have audio interface but only uses the data feature of the Telit GE864-QUAD ATEX, then this noise is not so disturbing and power supply layout design can be more forgiving.
- The PCB traces to the GE864-QUAD ATEX and the Bypass capacitor must be wide enough to ensure no significant voltage drops occur when the 2A current peaks are absorbed. This is for the same reason as previous point. Try to keep this trace as short as possible.
- The PCB traces connecting the Switching output to the inductor and the switching diode must be kept as short as possible by placing the inductor and the diode very close to the power switching IC (only for switching power supply). This is done in order to reduce the radiated field (noise) at the switching frequency (100-500 kHz).
- The use of a good common ground plane is suggested.
- The placement of the power supply on the board should be done in such a way
  to guarantee that the high current return paths in the ground plane are not
  overlapped to any noise sensitive circuitry as the microphone amplifier/buffer or
  earphone amplifier.
- The power supply input cables should be kept separate from noise sensitive lines such as microphone/earphone cables.





# 7. Antenna

The antenna connection and board layout design are the most important part in the full product design and they strongly reflect on the product overall performances, hence read carefully and follow the requirements and the guidelines for a proper design.

# 7.1. GSM Antenna Requirements

As suggested on the Product Description the antenna and antenna line on PCB for a Telit GE864-QUAD ATEX device shall fulfill the following requirements:

ANTENNA REQUIREMENTS	
Frequency range	Depending by frequency band(s) provided by the network operator, the customer shall use the most suitable antenna for that/those band(s)
Bandwidth	70 MHz in GSM850, 80 MHz in GSM900, 170 MHz in DCS & 140 MHz PCS band
Gain	Gain < 1,4dBi in GSM 850 & 900 and < 3,0dBi DCS & PCS
Impedance	50 ohm
Input power	> 2 W peak power
VSWR absolute max	<= 3:1
VSWR recommended	<= 2:1

When using the Telit GE864-QUAD ATEX, since there's no antenna connector on the module, the antenna must be connected to the GE864-QUAD ATEX through the PCB with the antenna pad.

In the case that the antenna is not directly developed on the same PCB, hence directly connected at the antenna pad of the GE864-QUAD ATEX, then a PCB line is needed in order to connect with it or with its connector.



This line of transmission shall fulfill the following requirements:

ANTENNA LINE ON PCB REQUIREMENTS		
Impedance	50 ohm	
Max Attenuation	0,3 dB	
No coupling with other signals allowed		
Cold End (Ground Plane) of antenna shall be equipotential to		
the GE864-QUAD ATEX ground pins		

Furthermore if the device is developed for the US market and/or Canada market, it shall comply to the FCC and/or IC approval requirements:

This device is to be used only for mobile and fixed application. The antenna(s) used for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter. End-Users must be provided with transmitter operation conditions for satisfying RF exposure compliance. OEM integrators must ensure that the end user has no manual instructions to remove or install the GE864-QUAD ATEX module. Antennas used for this OEM module must not exceed 3dBi gain for mobile and fixed operating configurations.

# 7.2. GSM Antenna - PCB line Guidelines

- Ensure that the antenna line impedance is 50 ohm;
- Keep the antenna line on the PCB as short as possible, since the antenna line loss shall be less than 0.3 dB;
- Antenna line must have uniform characteristics, constant cross section, avoid meanders and abrupt curves;
- Keep, if possible, one layer of the PCB used only for the Ground plane;
- Surround (on the sides, over and under) the antenna line on PCB with Ground, avoid having other signal tracks facing directly the antenna line track;
- The ground around the antenna line on PCB has to be strictly connected to the Ground Plane by placing vias once per 2mm at least:
- Place EM noisy devices as far as possible from GE864-QUAD ATEX antenna line;
- Keep the antenna line far away from the GE864-QUAD ATEX power supply lines;
- If you have EM noisy devices around the PCB hosting the GE864-QUAD ATEX, such as fast switching ICs, take care of the shielding of the antenna line by burying it inside the layers of PCB and surround it with Ground planes, or shield it with a metal frame cover.
- If you don't have EM noisy devices around the PCB of GE864-QUAD ATEX, by using a strip-line on the superficial copper layer for the antenna line, the line attenuation will be lower than a buried one;





# 7.3. GSM Antenna - Installation Guidelines

- Install the antenna in a place covered by the GSM signal.
- The Antenna must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter;
- Antenna shall not be installed inside metal cases
- Antenna shall be installed also according Antenna manufacturer instructions.



# 8. Logic level specifications

Where not specifically stated, all the interface circuits work at 2.8V CMOS logic levels. The following table shows the logic level specifications used in the **Telit GE864-QUAD ATEX** interface circuits:

#### Absolute Maximum Ratings -Not Functional

Parameter	Min	Max
Input level on any digital pin when on	-0.3V	+3.1V
Input voltage on analog pins when on	-0.3V	+3.0 V
Voltage on Buffered pins	-0.3V	25V

### Operating Range - Interface levels (2.8V CMOS)

Level	Min	Max
Input high level	2.1V	3.1V
Input low level	0V	0.5V
Output high level	2.2V	3.0V
Output low level	0V	0.35V

### For 1,8V signals:

### Operating Range - Interface levels (1.8V CMOS)

Level	Min	Max
Input high level	1.6V	2.2V
Input low level	0V	0.4V
Output high level	1,65V	2.2V
Output low level	0V	0.35V

#### **Current characteristics**

Level	Typical
Output Current	1mA
Input Current	1uA





### 8.1. Reset signal

Signal	Function	1/0	Bga Ball
RESET	Phone reset	J	A2

RESET is used to reset the **GE864-QUAD ATEX** module. Whenever this signal is pulled low, the GE864-QUAD ATEX is reset. When the device is reset it stops any operation. After the release of the reset GE864-QUAD ATEX is unconditionally shut down, without doing any detach operation from the network where it is registered. This behaviour is not a proper shut down because any GSM device is requested to issue a detach request on turn off. For this reason the Reset signal must not be used to normally shutting down the device, but only as an emergency exit in the rare case the device remains stuck waiting for some network response.

The RESET is internally controlled on start-up to achieve always a proper power-on reset sequence, so there's no need to control this pin on start-up. It may only be used to reset a device already on that is not responding to any command.

**NOTE**: do not use this signal to power off the **GE864-QUAD ATEX**. Use the ON/OFF signal to perform this function or the AT#SHDN command.

#### Reset Signal Operating levels:

Signal	Min	Max
RESET Input high	2.0V*	2.2V
RESET Input low	0V	0.2V

<sup>\*</sup> this signal is internally pulled up so the pin can be left floating if not used.

If unused, this signal may be left unconnected. If used, then it **must always be** connected with an open collector transistor, to permit to the internal circuitry the power on reset and under voltage lockout functions.



### 9. Serial Ports

The serial port on the Telit GE864-QUAD ATEX is the core of the interface between the module and OEM hardware.

2 serial ports are available on the module:

- MODEM SERIAL PORT
- MODEM SERIAL PORT 2 (DEBUG)

### 9.1. MODEM SERIAL PORT

Several configurations can be designed for the serial port on the OEM hardware, but the most common are:

- RS232 PC com port
- microcontroller UART @ 2.8V 3V (Universal Asynchronous Receive Transmit)
- microcontroller UART@ 5V or other voltages different from 2.8V

Depending from the type of serial port on the OEM hardware a level translator circuit may be needed to make the system work. The only configuration that doesn't need a level translation is the 2.8V UART.

The serial port on the GE864-QUAD ATEX is a +2.8V UART with all the 7 RS232 signals. It differs from the PC-RS232 in the signal polarity (RS232 is reversed) and levels. The levels for the GE864-QUAD ATEX UART are the CMOS levels:

#### Absolute Maximum Ratings -Not Functional

Parameter	Min	Max
Input level on any digital pad when on	-0.3V	+3.1V
Input voltage on analog pads when on	-0.3V	+3.0 V

### Operating Range - Interface levels (2.8V CMOS)

Level	Min	Max
Input high level V <sub>™</sub>	2.1V	3.1V
Input low level $V_{_{\rm IL}}$	0V	0.5V
Output high level $V_{\text{\tiny OH}}$	2.2V	3.0V
Output low level $V_{oL}$	0V	0.35V





### The signals of the GE864-QUAD ATEX serial port are:

RS232 Pin Number	Signal	GE864- QUAD ATEX Pad Number	Name	Usage
1	DCD - dcd_uart	D9	Data Carrier Detect	Output from the GE864-QUAD ATEX that indicates the carrier presence
2	RXD - tx_uart	H8	Transmit line *see Note	Output transmit line of GE864-QUAD ATEX UART
3	TXD - rx_uart	E7	Receive line *see Note	Input receive of the GE864-QUAD ATEX UART
4	DTR - dtr_uart	B7	Data Terminal Ready	Input to the GE864-QUAD ATEX that controls the DTE READY condition
5	GND	A1,F1,H1 L1, H2, L2, J3, K3	Ground	ground
6	DSR - dsr_uart	E11	Data Set Ready	Output from the GE864-QUAD ATEX that indicates the module is ready
7	RTS -rts_uart	F7	Request to Send	Input to the GE864-QUAD ATEX that controls the Hardware flow control
8	CTS - cts_uart	F6	Clear to Send	Output from the GE864-QUAD ATEX that controls the Hardware flow control
9	RI - ri_uart	B6	Ring Indicator	Output from the GE864-QUAD ATEX that indicates the incoming call condition



NOTE: According to V.24, RX/TX signal names are referred to the application side, therefore on the GE864 side these signal are on the opposite direction: TXD on the application side will be connected to the receive line (here named TXD/ rx\_uart ) of the GE864-QUAD ATEX serial port and vice versa for RX.

TIP: For a minimum implementation, only the TXD and RXD lines can be connected, the other lines can be left open provided a software flow control is implemented.



























### 9.2. RS232 level translation

In order to interface the Telit GE864-QUAD ATEX with a PC com port or a RS232 (EIA/TIA-232) application a level translator is required. This level translator must

- invert the electrical signal in both directions
- change the level from 0/3V to +15/-15V

Actually, the RS232 UART 16450, 16550, 16650 & 16750 chipsets accept signals with lower levels on the RS232 side (EIA/TIA-562), allowing for a lower voltage-multiplying ratio on the level translator. Note that the negative signal voltage must be less than 0V and hence some sort of level translation is always required.

The simplest way to translate the levels and invert the signal is by using a single chip level translator. There are a multitude of them, differing in the number of driver and receiver and in the levels (be sure to get a true RS232 level translator not a RS485 or other standards).

By convention the driver is the level translator from the 0-3V UART level to the RS232 level, while the receiver is the translator from RS232 level to 0-3V UART.

In order to translate the whole set of control lines of the UART you will need:

- 5 driver
- 3 receiver



**NOTE**: The digital input lines working at 2.8VCMOS have an absolute maximum input voltage of 3,1V; therefore the level translator IC shall not be powered by the +3.8V supply of the module. Instead it shall be powered from a +2.8V / +3.0V (dedicated) power supply.

This is because in this way the level translator IC outputs on the module side (i.e. GE864 inputs) will work at +3.8V interface levels, stressing the module inputs at its maximum input voltage.

This can be acceptable for evaluation purposes, but not on production devices.



**NOTE**: In order to be able to do in circuit reprogramming of the GE864 firmware, the serial port on the Telit GE864 shall be available for translation into RS232 and either it's controlling device shall be placed into tri-state, disconnected or as a gateway for the serial data when module reprogramming occurs.

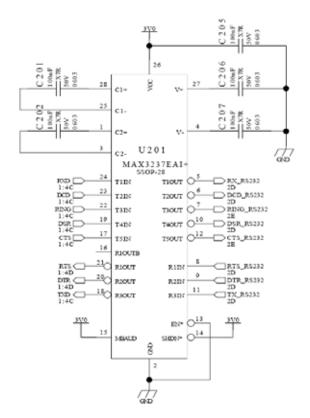
Only RXD, TXD, GND and the On/off module turn on pad are required to the reprogramming of the module, the other lines are unused.

All applicator shall include in their design such a way of reprogramming the GE864 – QUAD ATEX.



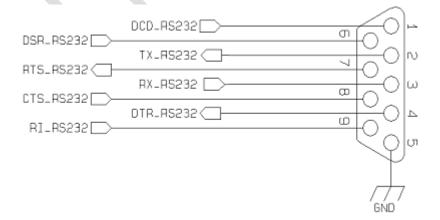


An example of level translation circuitry of this kind is:



RS232 LEVEL TRSANSLATOR

The RS232 serial port lines are connected to a DB9 connector with the following layout:

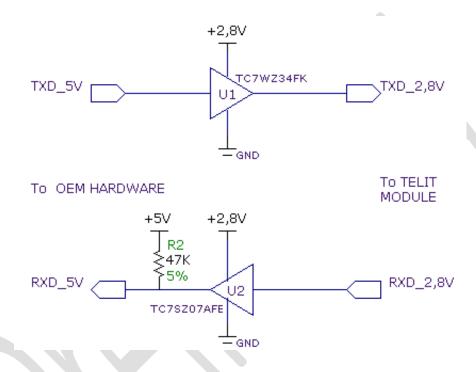






### 9.3. 5V UART level translation

If the OEM application uses a microcontroller with a serial port (UART) that works at a voltage different from 2.8 - 3V, then a circuitry has to be provided to adapt the different levels of the two set of signals. As for the RS232 translation there are a multitude of single chip translators. For example a possible translator circuit for a 5V TRANSMITTER/RECEIVER can be:





**TIP**: Note that the TC7SZ07AE has open drain output; therefore the resistor R2 is mandatory.







**NOTE**: The UART input line TXD (rx\_uart) of the GE864-QUAD ATEX is NOT internally pulled up with a resistor, so there may be the need to place an external  $47K\Omega$  pull-up resistor, either the DTR (dtr\_uart) and RTS (rts\_uart) input lines are not pulled up internally, so an external pull-up resistor of  $47K\Omega$  may be required.



Care must be taken to avoid latch-up on the GE864 –QUAD ATEX and the use of this output line to power electronic devices shall be avoided, especially for devices that generate spikes and noise such as switching level translators, micro controllers, failure in any of these condition can severely compromise the GE864 –QUAD ATEX functionality.



In case of reprogramming of the module has to be considered the use of the RESET line to start correctly the activity.

The preferable configuration is having an external supply for the buffer level translator.



## 10. Audio Section Overview

The first Baseband chip was developed for the cellular phones, which needed two separated amplifiers both in RX and in TX section.

A couple of amplifiers had to be used with internal audio transducers while the other couple of amplifiers had to be used with external audio transducers.

To distinguish the schematic signals and the Software identifiers, two different definitions were introduced, with the following meaning:

- internal audio transducers → HS/MT (from HandSet or MicroTelephone)
- external audio transducers  $\rightarrow HF$  (from HandsFree)

Actually the acronyms have not the original importance.

In other words this distinction is not necessary, being the performances between the two blocks like the same.

Only if the customer needs higher output power to drive the speaker, he needs to adopt the Aduio2 Section ( $\mathit{HF}$ ). Otherwise the choice could be done in order to overcome the PCB design difficulties.

For these reasons we have not changed the *HS* and *HF* acronyms, keeping them in the Software and on the schematics.

The Base Band Chip of the GE864-QUAD ATEX Telit Modules maintains the same architecture.

For more information and suggestions refer to Telit document:

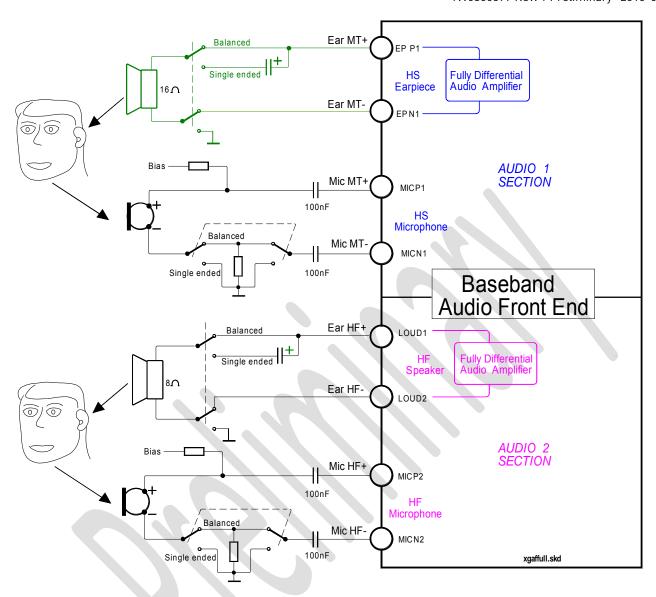
Audio settings application note, 80000NT10007a

#### 10.1. Selection mode

Only one block can be active at a time, and the activation of the requested audio path is done via hardware ,by AXE line, or via software ,by AT#CAP command .

Moreover the *Sidetone* functionality could be implemented by the amplifier fitted between the transmit path and the receive path, enabled at request in both modes.





GE864-QUAD ATEX Audio Front End Block Diagram



#### 10.2. Electrical Characteristics



TIP: Being the microphone circuitry the more noise sensitive, its design and layout must be done with particular care. Both microphone paths are balanced and the OEM circuitry must be balanced designed to reduce the common mode noise typically generated on the ground plane. However the customer can use the unbalanced circuitry for its particular application.

### 10.2.1. Input Lines Characteristics

"MIC_MT" and "MIC_HF" paths	differential microphone
Line Coupling	AC*
Line Type	Balanced
Differential input voltage	$\leq$ 1,03V <sub>pp</sub> G <i>Mic G=0dB</i>
Gain steps	7
Gain increment	6dB per step
Coupling capacitor	≥ 100nF
Differential input resistance	50ΚΩ
Input capacitance	• 10pF



(\*) WARNING: AC means that the signals from the microphone have to be connected to input lines of the module through capacitors which value has to be  $\geq 100$ nF. Not respecting this constraint, the input stages will be damaged.

**WARNING:** when particular OEM application needs a *Single Ended Input* configuration, it is forbidden connecting the unused input directly to Ground, but only through a 100nF capacitor. Don't forget that the useful input signal will be halved in *Single Ended Input* configuration.



### 10.2.2. Output Lines Characteristics



#### TIP:

We suggest driving the load differentially from both output drivers, thus the output swing will double and the need for the output coupling capacitor avoided. However if particular OEM application needs also a *Single Ended circuitry* can be implemented, but the output power will be reduced four times.

The OEM circuitry shall be designed to reduce the common mode noise typically generated on the ground plane and to get the maximum power output from the device (low resistance tracks).



#### WARNING:

The loads are directly connected to the amplifier outputs when in *Differential* configuration, through a capacitor when in *Single Ended* configuration. Using a *Single Ended configuration*, the unused output line must be left open. Not respecting this constraint, the output stage will be damaged.



#### TIP:

Remember that there are slightly different electrical performances between the two internal audio amplifiers:

- the "Ear\_MT" lines can directly drive a 16Ω load at -12dBFS (\*\*) in Differential configuration
- the "Ear\_HF" lines can directly drive a  $4\Omega$  load in Differential configurations
- There is no difference if the amplifiers drive an external amplifier

(\*\*) OdBFS is the normalized overall Analog Gain for each Output channel equal to  $3.7V_{out}$  differential





"EAR_MT" O	utput Lines
line coupling	AC single-ended DC differential
OdBFS normalized gain	3,7 V <sub>pp</sub> differential
output load resistance	≥ 16 Ω <i>@ -12dBFS</i>
internal output resistance	4Ω ( <i>typical</i> )
signal bandwidth	150 - 4000 Hz @ -3 dB
maximal full scale differential output voltage differential output voltage	3,7 V <sub>m</sub> (typical) Rload=open circuit 925mV <sub>m</sub> / Rload=16Ω <i>@ -12dBFS</i>
volume increment	2 dB per step
volume steps	10

"EAR_HF"	Output Lines
line coupling	AC single-ended DC differential
output load resistance	≥8Ω
signal bandwidth	150 - 4000 Hz @ -3 dB
maximal output power @ battery voltage ≥ 3,6V	0.35 W <sub>rms</sub> /8 Ω
volume increment	2 dB per step
volume steps	10



























## 11. General Purpose I/O

The general purpose I/O pads can be configured to act in three different ways:

- input
- output
- alternate function (internally controlled)

Input pads can only be read and report the digital value (high or low) present on the pad at the read time; output pads can only be written or queried and set the value of the pad output; an alternate function pad is internally controlled by the GE864-QUAD ATEX firmware and acts depending on the function implemented. For Logic levels please refer to chapter 8.

The following GPIO are available on the GE864-QUAD ATEX:

Ball	Signal	1/0	Function	Туре	Input / output current	Default State	State during Reset	Note
В3	GPI0_04	1/0	GPI004 Configurable GPI0	CMOS 2.8V	1uA / 1mA	INPUT	0	Alternate function (RF Transmission Control)
В5	GPI0_06	1/0	GPI006 Configurable GPI0	CMOS 2.8V	1uA / 1mA	INPUT	0	Alternate function (ALARM)
E6	GPI0_01	1/0	GPI001 Configurable GPI0	CMOS 2.8V	1uA / 1mA	INPUT	0	Alternate function (JDR)
Н3	GPI0_08	1/0	GPI008 Configurable GPI0	CMOS 2.8V	1uA / 1mA	INPUT	0	PCM_TX
H5	GPI0_02	1/0	GPI002 Configurable GPI0	CMOS 2.8V	1uA / 1mA	INPUT	0	PCM_WA0
K7	GPI0_03	1/0	GPI003 Configurable GPI0	CMOS 2.8V	1uA / 1mA	INPUT	0	PCM_RX
K8	GPI0_05	1/0	GPI005 Configurable GPI0	CMOS 2.8V	1uA / 1mA	INPUT	0	Alternate function (RFTXMON)
L9	GPI0_07	1/0	GPI007 Configurable GPI0	CMOS 2.8V	1uA / 1mA	INPUT	0	Alternate function (BUZZER)
D7	GPIO_09 / PCM_CLK	1/0	GPI009 Configurable GPI0	CMOS 2.8V	1uA / 1mA	INPUT	0	PCM audio

Not all GPIO pads support all these three modes:

- GPI01 supports all three modes and can be input, output, Jamming Detect Output (Alternate function)
- GPI04 supports all three modes and can be input, output, RF Transmission Control (Alternate function)
- GPI05 supports all three modes and can be input, output, RFTX monitor output (Alternate function)
- GPIO6 supports all three modes and can be input, output, alarm output (Alternate function)
- GPI07 supports all three modes and can be input, output, buzzer output (Alternate function)





#### 11.1. **GPIO Logic levels**

Where not specifically stated, all the interface circuits work at 2.8V CMOS logic levels. The following table shows the logic level specifications used in the GE864-QUAD ATEX interface circuits:

Absolute Maximum Ratings -Not Functional

Parameter	Min	Max
Input level on any digital pin when on	-0.3V	+3.1V
Input voltage on analog pins when on	-0.3V	+3.0 V

Operating Range - Interface levels (2.8V CMOS)

Level	Min	Max
Input high level	2.1V	3.1V
Input low level	0V	0.5V
Output high level	2.2V	3.0V
Output low level	OV	0.35V



### 11.2. Using a GPIO Pad as INPUT

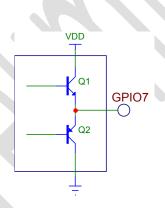
The GPIO pads, when used as inputs, can be connected to a digital output of another device and report its status, provided this device has interface levels compatible with the 2.8V CMOS levels of the GPIO.

If the digital output of the device to be connected with the GPIO input pad has interface levels different from the 2.8V CMOS, then it can be buffered with an open collector transistor with a 47K pull up to 2.8V, this pull up must be switched off when the module is in off condition.

## 11.3. Using a GPIO Pad as OUTPUT

The GPIO pads, when used as outputs, can drive 2.8V CMOS digital devices or compatible hardware. When set as outputs, the pads have a push-pull output and therefore the pull-up resistor may be omitted.

The illustration below shows the base circuit of a push-pull stage:



### 11.4. Using the RF Transmission Control GPI04

The GPIO4 pin, when configured as RF Transmission Control Input, permits to disable the Transmitter when the GPIO is set to Low by the application.

In the design is necessary to add a resistor 47K pull up to 2.8V, this pull up must be switched off when the module is in off condition.





## 11.5. Using the RFTXMON Output GPI05

The GPI05 pin, when configured as RFTXMON Output, is controlled by the module and will rise when the transmitter is active and fall after the transmitter activity is completed.

For example, if a call is started, the line will be HIGH during all the conversation and it will be again LOW after hanged up.

The line rises up 300ms before first TX burst and will became again LOW from 500ms to 1sec after last TX burst.

## 11.6. Using the Alarm Output GPI06

The GPIO6 pad, when configured as Alarm Output, is controlled by the module and will rise when the alarm starts and fall after the issue of a dedicated AT command.

This output can be used to power up the module controlling microcontroller or application at the alarm time, giving you the possibility to program a timely system wake-up to achieve some periodic actions and completely turn off either the application and the module during sleep periods, dramatically reducing the sleep consumption to few  $\mu A$ .

In battery-powered devices this feature will greatly improve the autonomy of the device.



**NOTE**: During RESET the line is set to HIGH logic level.

## 11.7. Using the Buzzer Output GPI07

As *Alternate Function*, the GPI07 is controlled by the firmware that depends on the function implemented internally.

This setup places always the GPI07 pin in *OUTPUT* direction and the corresponding function must be activated properly by **AT#SRP** command (refer to *AT commands specification*).

Also in this case, the *dummy value* for the pin state can be both " $\mathcal{O}$ " or " $\mathcal{I}$ ".

• Send the command AT#GPI0=7, 1, 2<cr>:

• Wait for response OK

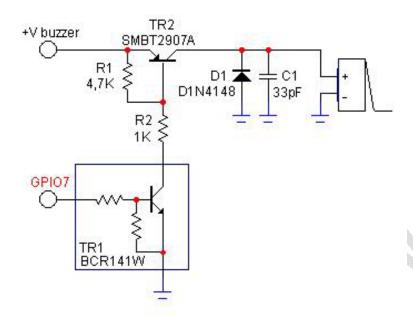
• Send the command AT#SRP=3

The GPI07 pin will be set as *Alternate Function* pin with its *dummy* logic status set to *HIGH* value.

The "Alternate Function" permits your application to easily implement **Buzzer feature** with some small hardware extension of your application as shown in the sample figure below.







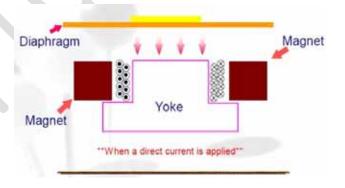


**NOTE**: To correctly drive a buzzer a driver must be provided, its characteristics depend on the Buzzer and for them refer to your buzzer vendor.

## 11.8. Magnetic Buzzer Concepts

## 11.8.1. Short Description

A magnetic Buzzer is a sound-generating device with a coil located in the magnetic circuit consisting of a permanent magnet, an iron core, a high permeable metal disk, and a vibrating diaphragm.

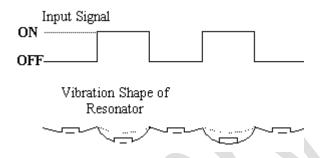


Drawing of the Magnetic Buzzer





The disk and diaphragm are attracted to the core by the magnetic field. When an oscillating signal is moved through the coil, it produces a fluctuating magnetic field, which vibrates the diaphragm at a frequency of the drive signal. Thus the sound is produced relative to the frequency applied.



Diaphragm movement

### 11.8.2. Frequency Behavior

The frequency behavior represents the effectiveness of the reproduction of the applied signals.

Because its performance is related to a square driving waveform (whose amplitude varies from 0V to Vpp), if you modify the waveform (e.g. from square to sinus) the frequency response will change.

## 11.8.3. Power Supply Influence

Applying a signal whose amplitude is different from that suggested by manufacturer, the performance change following the rule:

if resonance frequency  $f_0$  increases, amplitude decreases.

Because of resonance frequency depends from acoustic design, lowering the amplitude of the driving signal the response bandwidth tends to become narrow, and vice versa.

Summarizing:  $Vpp \uparrow \rightarrow f_{\circ} \downarrow$   $Vpp \downarrow \rightarrow f_{\circ} \uparrow$ 

The risk is that the  $f_{\circ}$  could easily fall outside of new bandwidth; consequently the SPL could be much lower than the expected.

## 11.8.4. Warning

It is very important to respect the sense of the applied voltage: never apply to the "-" pin a voltage more positive than the "+" pin. If this happens, the diaphragm vibrates in the opposite sense with a high probability to be expelled from its physical position, damaging the device forever.





### 11.8.5. Working Current Influence

In the component data sheet you will find the value of MAX CURRENT that represents the maximum average current that can flow at nominal voltage without current limitation.

In other words it is not the peak current, which could be twice or three times higher. If driving circuitry does not support these peak values, the SPL will never reach the declared level or the oscillations will stop.





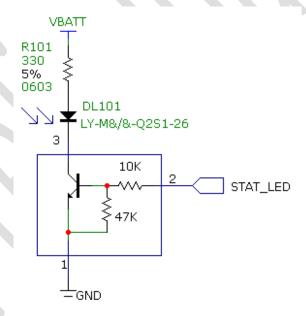
## 11.9. Indication of network service availability

The STAT\_LED pin status shows information on the network service availability and Call status.

In the GE864-QUAD ATEX modules, the STAT\_LED needs an external transistor to drive an external LED.

Therefore, the status indicated in the following table is reversed with respect to the pin status.

LED status	Device Status
Permanently off	Device off
Fast blinking (Period 1s, Ton 0,5s)	Net search / Not registered / turning off
Slow blinking (Period 3s, Ton 0,3s)	Registered full service
Permanently on	a call is active





## 11.10. RTC Bypass Out

The VRTC pin brings out the Real Time Clock supply, which is separate from the rest of the digital part, allowing having only RTC going on when all the other parts of the device are off.

To this power output a backup capacitor can be added in order to increase the RTC autonomy during power off of the battery. NO Devices must be powered from this pin.





### 12. DAC and ADC section

### 12.1. DAC Converter

### 12.1.1. Description

The GE864-QUAD ATEX module provides a Digital to Analog Converter. The signal (named DAC\_OUT) is available on BGA Ball C7 of the GE864-QUAD ATEX module and on pin 17 of PL102 on EVK2 Board (CS1302).

The on board DAC is a 10-bit converter, able to generate a analogue value based a specific input in the range from 0 up to 1023. However, an external low-pass filter is necessary

	Min	Max	Units
Voltage range (filtered)	0	2,6	Volt
Range	0	1023	Steps

The precision is 10 bits so, if we consider that the maximum voltage is 2V, the integrated voltage could be calculated with the following formula:

Integrated output voltage = 2 \* value / 1023

DAC\_OUT line must be integrated (for example with a low band pass filter) in order to obtain an analog voltage.



### 12.1.2. Enabling DAC

An AT command is available to use the DAC function. The command is AT#DAC[=<enable>[,<value>]]

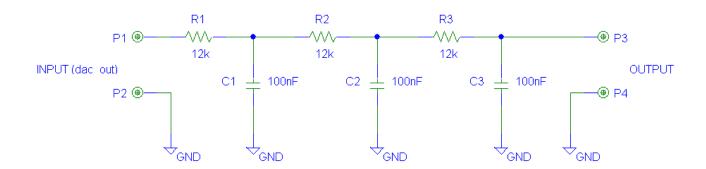
<value> - scale factor of the integrated output voltage (0..1023 - 10 bit precision)
it must be present if <enable>=1

Refer to SW User Guide or AT Commands Reference Guide for the full description of this function.



**NOTE**: The DAC frequency is selected internally. D/A converter must not be used during POWERSAVING.

### 12.1.3. Low Pass Filter Example



### 12.2. ADC Converter

## 12.2.1. Description

The on board A/D are 11-bit converter. They are able to read a voltage level in the range of  $0 \div 1.9$  volts applied on the ADC pin input, store and convert it into 11 bit word.





	Min	Max	Units
Input Voltage range	0	2.0	Volt
AD conversion	-	11	bits
Resolution	_	< 1	mV

The GE864-QUAD ATEX module provides 2 Analog to Digital Converters. The input lines are:

ADC\_IN1 available on Ball J11 and Pin 19 of PL102 on EVK2 Board. ADC\_IN2 available on Ball H11 and Pin 20 of PL102 on EVK2 Board.

### 12.2.2. Using ADC Converter

An AT command is available to use the ADC function.

The command is AT#ADC=1,2

The read value is expressed in mV

Refer to SW User Guide or AT Commands Reference Guide for the full description of this function.



## 12.3. Debug of the GE864-QUAD ATEX in Production

To test and debug the mounting of the GE864-QUAD ATEX, we strongly recommend to foreseen test pads on the host PCB, in order to check the connection between the GE864-QUAD ATEX itself and the application and to test the performance of the module connecting it with an external computer. Depending by the customer application, these pads include, but are not limited to the following signals:

Ball	Signal	Function
J1, J2, K1, K2	VBATT	Main power supply
A1, A11, D6, F1,		
F11, H1, H2, J3,		
K3, K4, K5, K6,	GND	Ground
L1, L2, L3, L6,		
L11		
E7	C103/TXD	Serial data input (TXD) from DTE
H8	C104/RXD	Serial data output (RXD) to DTE
L8	PRWMON	Power ON Monitor
J5	ON/OFF*	Input command for switching power ON or OFF
33	014/011	(toggle command).
A2	RESET*	Reset input
F10	RX_TRACE	RX Data for debug monitor
D11	TX_TRACE	TX Data for debug monitor
H4	SERVICE	SERVICE connection

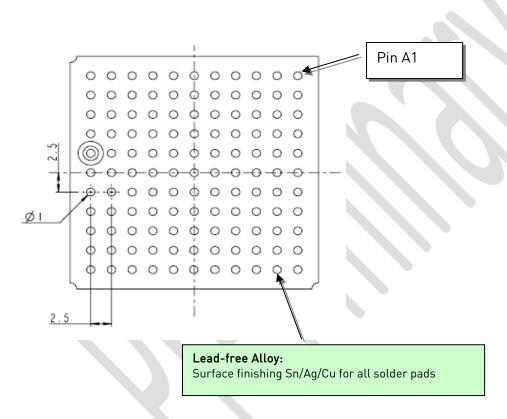


## 12.4. Mounting the GE864-QUAD ATEX on your Board

### 12.4.1. General

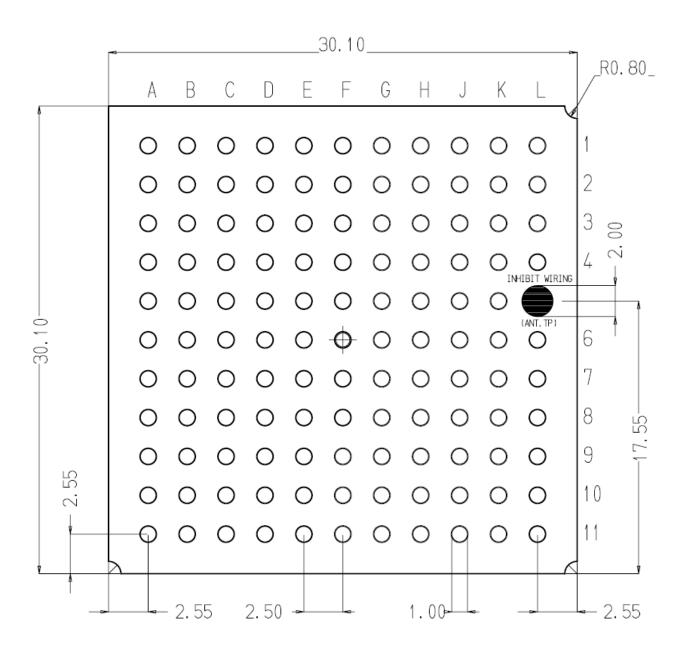
The **Telit GE864-QUAD ATEX modules** have been designed in order to be compliant with a standard lead-free SMT process.

### 12.4.2. Module finishing & dimensions





### 12.4.3. Recommended foot print for the application (GE864)



Top View





## 12.4.4. Stencil

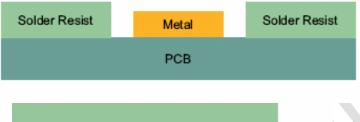
Stencil's apertures layout can be the same of the recommended footprint (1:1), we suggest a thickness of stencil foil  $\geq$  120 $\mu$ m.

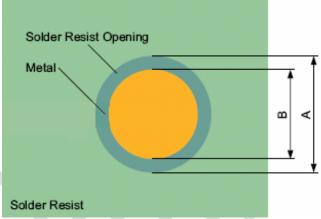




### 12.4.5. PCB pad design

Non solder mask defined" (NSMD) type is recommended for the solder pads on the PCB.



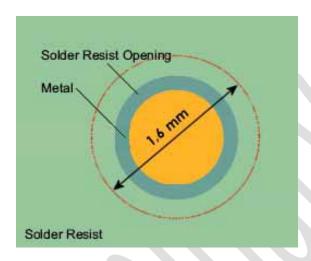


Recommendations for PCB pad dimensions

Ball pitch [mm]	2,5
Solder resist opening diameter A [mm]	1,150
Metal pad diameter B [mm]	1 ± 0.05



It is not recommended to place via or microvia not covered by solder resist in an area of 1,6mm diameter around the pads unless it carries the same signal of the pad itself. (see following figure).



Holes in pad are allowed only for blind holes and not for through holes.

Recommendations for PCB pad surfaces:

Finish	Layer thickness [µm]	Properties
Electro-less Ni /	3 –7 /	good solder ability protection, high
Immersion Au	0.05 - 0.15	shear force values

The PCB must be able to resist the higher temperatures which are occurring at the lead-free process. This issue should be discussed with the PCB-supplier. Generally, the wettability of tin-lead solder paste on the described surface plating is better compared to lead-free solder paste.

### 12.4.6. Solder paste

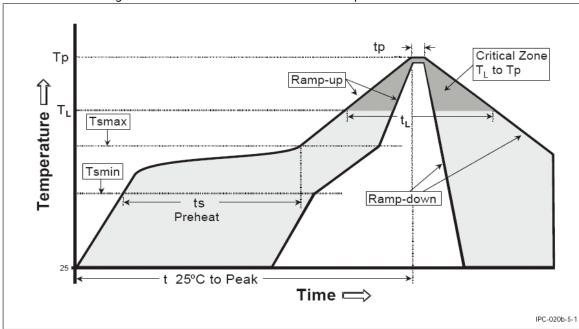
	Lead free
Solder paste	Sn/Ag/Cu





### 12.4.7. GE864 ATEX Solder reflow

The following is the recommended solder reflow profile



Profile Feature	Pb-Free Assembly
Average ramp-up rate $(T_L \text{ to } T_P)$	3°C/second max
Preheat	
– Temperature Min (Tsmin)	150°C
– Temperature Max (Tsmax)	200°C
– Time (min to max) (ts)	60-180 seconds
Tsmax to TL	
– Ramp-up Rate	3°C/second max
Time maintained above:	
– Temperature (TL)	217°C
– Time (tL)	60-150 seconds
Peak Temperature (Tp)	245 +0/-5°C
Time within 5°C of actual Peak	10-30 seconds
Temperature (tp)	
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.



**NOTE**: All temperatures refer to topside of the package, measured on the package body surface.

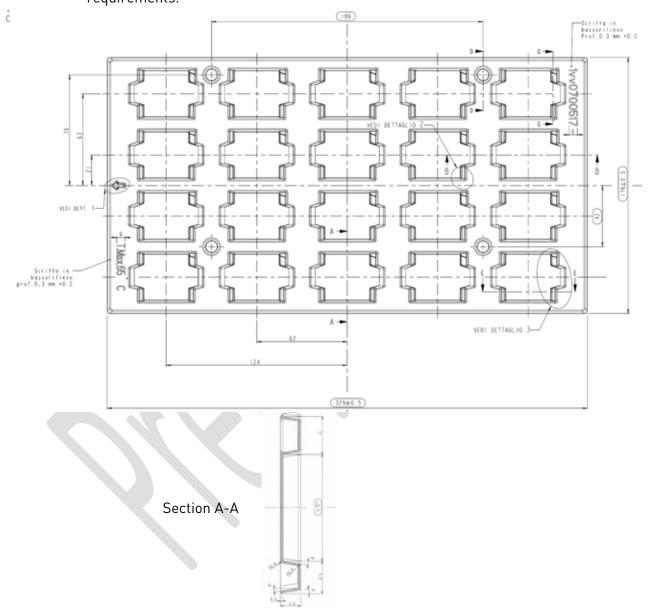
WARNING: GE864 module can accept only one reflow process





## 12.5. Packing system

The **Telit GE864 modules** are packaged on trays of 20 pieces each. This is especially suitable for the GE864 according to SMT processes for pick & place movement requirements.



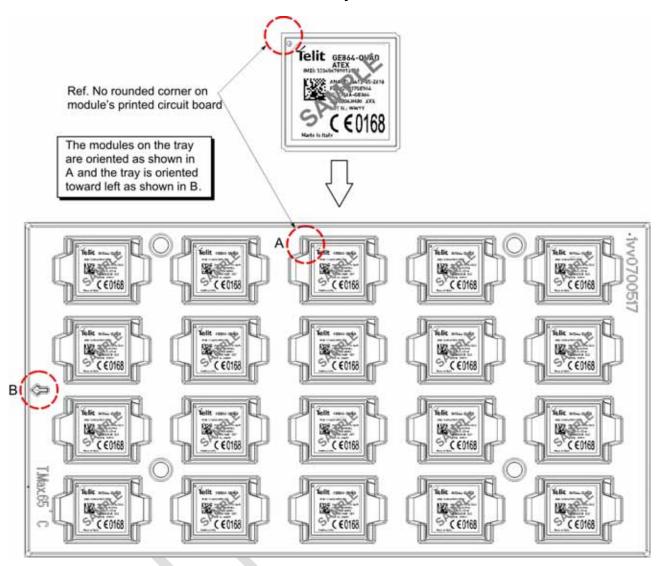
The size of the tray is: 329 x 176mm

WARNING: These trays can withstand at the maximum temperature of 65° C.





### 12.5.1. GE864 orientation on the tray



## 12.5.2. Moisture sensibility

The level of moisture sensibility of **GE864** module is "3", in according with standard IPC/JEDEC J-STD-020, take care all the relatives requirements for using this kind of components.



## 13. Conformity Assessment Issues

The GE864-QUAD ATEX module is assessed to be conform to the R&TTE Directive as stand-alone products, so If the module is installed in conformance with Dai Telecom installation instructions require no further evaluation under Article 3.2 of the R&TTE Directive and do not require further involvement of a R&TTE Directive Notified Body for the final product.

In all other cases, or if the manufacturer of the final product is in doubt then the equipment integrating the radio module must be assessed against Article 3.2 of the R&TTE Directive.

In all cases assessment of the final product must be made against the Essential requirements of the R&TTE Directive Articles 3.1(a) and (b), safety and EMC respectively, and any relevant Article 3.3 requirements.

The GE864-QUAD ATEX module is conforming with the following European Union Directives:

- R&TTE Directive 1999/5/EC (Radio Equipment & Telecommunications Terminal Equipments)
- Low Voltage Directive 73/23/EEC and product safety
- Directive 89/336/EEC for conformity for EMC
- In order to satisfy the essential requisite of the R&TTE 99/5/EC directive, the GE864-QUAD ATEX module is compliant with the following standards:
- GSM (Radio Spectrum). Standard: EN 301 511 and 3GPP 51.010-1
- EMC (Electromagnetic Compatibility). Standards: EN 301 489-1 and EN 301 489-7
- LVD (Low Voltage Directive) Standards: EN 60 950

In this document and the Hardware User Guide, Software User Guide all the information you may need for developing a product meeting the R&TTE Directive is included.

. Furthermore The Telit GE864-QUAD Atex is assessed to be conform to the ATEX Directive

Telit GE864-QUAD Atex is conforming to the following European Union Directives:

• ATEX Directive 1994/9/EC (Explosive Atmospheres)

 $\langle \xi_{x} \rangle$ 

In order to satisfy the essential requisite of the ATEX 94/9/EC directive,





the GE864-QUAD Atex module is compliant with the following standards:

- •
- IEC EN 60079-0 (electrical apparatus for explosive gas atmospheres general requirements)
- IEC EN 60079-11 (explosive atmospheres: Equipment protection by intrinsic safety "I")
- IEC EN 60079-26 (explosive atmospheres: Equipment with equipment protection level (EPL) Ga

All certifications are available in GE864-QUAD ATEX Product Description.





### 14. SAFETY RECOMMANDATIONS

#### **READ CAREFULLY**

#### Introduction

These safety instructions contains data and information related to the protection to be adopted for the installation of GE864-QUAD ATEX in hazardous areas classified according to the European standard EN 60079-10.

The essential safety requirements against the risk of explosion in classified areas are given in the European directives 94/9/CE dated 23 March 1994 (related to equipments) and 1999/92/CE dated 16 December 1999 (related to user plants).

**WARNING**: Operations of assembling, installing, starting and servicing instruments in hazardous areas, can be executed only by qualified personnel specifically trained to perform these activities in areas with explosive gas atmospheres with reference to the safety standards

**WARNING**: Deviation from installation procedures and conditions specified in this document and/or in the operator manual may invalidate the product's conformity with the 94/9/CE (ATEX) directive



### Marking

The components GE864-QUAD ATEX have the following marking plates and have been certified to comply with Directive 94/9/EC.

Following the possible type of plates.



#### MARKING PLATES



The information provided on the plates illustrated in Figure 1 are:

Telit: company name

Via Stazione di Prosecco 5A, Sgonico (TS) Italy

Tel +39 0404192111, www.telit.com

GE864-QUAD :Product series identification.

IMEI.....: International Mobile Equipment Identity.

Mark denoting product compliance to the directive 94/9/EC (ATEX) and to the directive 89/336/EEC modified by the 93/68/EEC (EMC) + RTTE.

Specific mark for protection from explosion.

**0051**: Number of notified body engaged for surveillance.

**II 1 G**: Suitable for use in locations other than mines, with presence of gases or vapours. Suitable f or installation in Zone 0 and, with redundance in

Zone 1 or Zone 2.

IMQ: Acronym of notified body responsible for EC-Type examination.

**09**: Year certificate issue. **IMQ 09 ATEX 039U**: Number of ATEX certificate.

Ex ia: Protection concept Intrinsic Safety.





II C: Gas Group IIC (Hydrogen – Acetylene).

T4: Temperature class (related to the hot surface ignition

temperature) for gas.

Ui: Maximum voltage.

Ii: Maximum current.

Pi: Maximum power.

Ci: Maximum capacitance.

Li: Maximum inductance.

### Limit conditions for safe use (U)

- a) The component transmitters RF 864-QUAD ATEX shall be mounted in other devices for the conformity of the product, which respect the intrinsically safe parameters shown in the label
- b) The component transmitters RF GE864-QUAD ATEX, shall met to the instruments of communication with ATEX certification according the temperature class T4 minimum.



**NOTE**: The transmitters are certified for the use in areas with presence of gas or vapours group IIC (Hydrogen), therefore they are suitable also for the use in areas with presence of gas or vapours group IIB (Ethylene) and IIA (Propane).

The transmitters are certified for application with temperature class T4, therefore they are suitable also for higher temperature class T3, T4.



### Mounting and Installation

Mounting and wiring operations in classified areas for explosive gas atmospheres, must be executed accordingly to the current procedures and to the national and international standards (e.g. EN 60079-14) only by qualified personnel specifically and completely trained.

For the handling, mounting and wiring refer to the operator manual instructions.

Supply power to the transmitter by means of an apparatus certified for the protection mode Ex ia IIC T4 according to the European standards EN 60079-0 and EN 60079-11 with the following limits:





Rated max. voltage Ui = 4.2 V; Short circuit current Ii = 2.5 A; Maximum transferred power Pi = 10.5 W Li= 60.7 nH Ci=30.2 uF

### Specific parameters for IIC Gas Group

Pi = 5.3 W Ui = 3.8 V Ii = 1.4 A

### Specific parameters for IIA/IIB Gas Group

Pi = 10.5 W Ui = 4.2 V Ii = 2.5 A

With the above Ui and Ii parameters, the component is suitable to be used in equipment with the following class:

4	Ambient	Temperature
	Temperature	Class
	- 20°C ÷ +	T4
4	80°C	

### Start Up

Before starting up the instrument it must be verified that:

- The correctness of the mounting on the specific final PWB layout.
- The correctness of the electronic mounting and of the power supply.

### Inspection and Maintenance

Inspection and maintenance of electrical installations in hazardous areas have to be carried out according to the EN 60079-17 standard.



### Repair, overhaul and reclaiming.

The reparation of the intrinsic safety instruments have to be executed only by the manufacturer or by a repair shop authorized / qualified by the manufacturer itself (according e.g. EN 60079-19 standard).

The repairing must be done complying all the safety parameters.



**NOTE**: In the event that, after the repairing, the safety parameters of the specific protection mode are not valid anymore, the identification label is removed and the transmitter cannot be considered as a safety instrument

Be sure the use of this product is allowed in the country and in the environment required. The use of this product may be dangerous and has to be avoided in the following areas:

- Where it can interfere with other electronic devices in environments such as hospitals, airports, aircrafts, etc
- Where there is risk of explosion such as gasoline stations, oil refineries, etc

It is responsibility of the user to enforce the country regulation and the specific environment regulation.

Do not disassemble the product; any mark of tampering will compromise the warranty validity.

We recommend following the instructions of the hardware user guides for a correct wiring of the product. The product has to be supplied with a stabilized voltage source and the wiring has to be conforming to the security and fire prevention regulations.

The product has to be handled with care, avoiding any contact with the pins because electrostatic discharges may damage the product itself. Same cautions have to be taken for the SIM, checking carefully the instruction for its use. Do not insert or remove the SIM when the product is in power saving mode.

The system integrator is responsible of the functioning of the final product; therefore, care has to be taken to the external components of the module, as well as of any project or installation issue, because the risk of disturbing the GSM network or external devices or having impact on the security. Should there be any doubt, please refer to the technical documentation and the regulations in force.

Every module has to be equipped with a proper antenna with specific characteristics. The antenna has to be installed with care in order to avoid any interference with other





























electronic devices and has to guarantee a minimum distance from the body (20 cm). In case of this requirement cannot be satisfied, the system integrator has to assess the final product against the SAR regulation EN 50360.

The European Community provides some Directives for the electronic equipments introduced on the market. All the relevant information's are available on the European Community website:

### http://europa.eu.int/comm/enterprise/rtte/dir99-5.htm

The text of the Directive 99/05 regarding telecommunication equipments is available, while the applicable Directives (Low Voltage and EMC) are available at:

http://europa.eu.int/comm/enterprise/electr\_equipment/index\_en.htm